

贊助機構

Sponsor



由香港特別行政區政府
「發展品牌、升級轉型及拓展內銷市場的
專項基金」(機構支援計劃)撥款資助
Funded by the Dedicated Fund on Branding,
Upgrading and Domestic Sales (Organisation
Support Programme) of the Government of
the Hong Kong Special Administrative Region

主辦機構

Organizer



香港表面處理學會
Hong Kong Surface
Finishing Society

執行機構

Implementation organisation



Hong Kong Productivity Council
香港生產力促進局

香港表面處理行業升級轉型： 3C 及電子產品技術研討會

費用全免
Free of Charge

Upgrading Hong Kong Surface Finishing Industries:

Electronics & 3C Product Technology Seminar

日期：2015 年 6 月 3 日 (星期三)

Date: 3 June 2015 (Wednesday)

時間：上午 11 時 30 分至下午 3 時 15 分

Time: 11:30 am – 3:15 pm

地點：廣東現代國際展覽中心 3 號館 C 區 (廣東省東莞市厚街鎮 S256 省道與家居大道交界)

Venue: Guangdong Modern International Exhibition Center (Dongguan • Houjie)

背景：

是次研討會將以 3C 及電子產品為主題，分析現時表面處理行業所面對的經營及技術困難、產業升級的實際差距及可行性，分享最新的技術應用，及打進高增值市場的建議方案。

- 市場趨勢及需求
- 產品設計及技術研發
- 環保及法規
- 升級轉型策略方案



Background:

The technology seminar, focusing on 3C and electronics products, will analyze the current business and technological difficulties that the Hong Kong surface finishing company are facing. The seminar will discuss the gap and feasibility of industry upgrade, share the latest technology application, and propose solutions for entering high value-added component markets.

- Market trend and requirement
- Product design and technology innovation
- Environmental and compliance
- Industry upgrade solution



費用：全免 (為免向隅，敬請預先報名)

人數：50 人

Fee: Free of Charge (Prior enrollment is necessary)

Target number of Audience: 50

協辦機構

Collaborating Organization



香港電鍍業商會
Hong Kong Electro-Plating
Merchants Association

支持機構 (排名不分先後)

Supporting Organizations (listed in arbitrary order)



香港創新科技及製造業聯合總會
Hong Kong Federation of Innovative Technologies
and Manufacturing Industries



香港汽車零部件工業協會
Hong Kong Auto Parts Industry Association



香港電器業協會
HONG KONG ELECTRICAL APPLIANCE
INDUSTRIES ASSOCIATION



香港醫療及保健器材行業協會
Hong Kong Medical and Healthcare Products Industry Association



HONG KONG
ELECTRONICS &
TECHNOLOGIES ASSOCIATION
香港電子科技商會



Hong Kong Aviation
Industry Association
香港航空業協會

「在此刊物上 / 活動內 (或項目小組成員) 表達的任何意見、研究成果、結論或建議，並不代表香港特別行政區政府、工業貿易署或中小企業發展支援基金及發展品牌、升級轉型及拓展內銷市場的專項基金 (機構支援計劃) 評審委員會的觀點。」

Any opinions, findings, conclusions or recommendations expressed in this material/event (or by members of the Project team) do not reflect the views of the Government of the Hong Kong Special Administrative Region, Trade and Industry Department or the Vetting Committee for the SME Development Fund and the Dedicated Fund on Branding, Upgrading and Domestic Sales (Organisation Support Programme).

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詳細內容 Seminar Programme

時間 Time	程序 Programme
11:15 - 11:30	接待及登記 Registration
11:30 - 12:30	<p>最新電子表面處理行業的環保技術及設備分享 Sharing on the latest environmental technology and equipment application for surface finishing on electronics product 得力 (中国-香港) 有限公司 Technic (China-HK) Limited 何俊文先生 Mr. Simon Ho</p>
12:30 - 13:30	午休 Lunch break
13:30 - 14:00	<p>最新技術展覽會分享: 2015 上海半導體展與表面處理行業應用 The latest technology exhibition: SEMICON China 2015 for surface finishing application 香港生產力促進局 Hong Kong Productivity Council 游文仁先生 Mr. Eric Yau</p> 
14:00 - 14:30	<p>企業升級轉型分享: 表面處理市場需求及企業升級轉型方案 Upgrading the surface finishing industry: Market requirement and upgrading solution for surface finishing industry 香港生產力促進局 Hong Kong Productivity Council 關志輝先生 Mr. Eric Kwan</p>
14:30 - 15:15	<p>3C 電子產品的最新電鍍技術應用及市場發展 The latest electro-plating application and market development on 3C electronics products 安美特化學有限公司 Atotech Asia Pacific Limited 李清清先生 Mr. Benjamin Li</p> 

備註：主辦機構保留權利可更改調動論壇題目、內容及講者而不須先行通知。

Note: The organizer reserves the right to alter the topic / content / speaker of the forum programme without prior notice.

Online Registration Link:

<http://events.hkpc.org/register.php?code=20150603>

網上報名，請按此

Online registration

「在此刊物上 / 活動內 (或項目小組成員) 表達的任何意見、研究成果、結論或建議，並不代表香港特別行政區政府、工業貿易署或中小企業發展支援基金及發展品牌、升級轉型及拓展內銷市場的專項基金 (機構支援計劃) 評審委員會的觀點。」

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Enrollment Form

報名表

Attention: Ms May Lau. Fax No. +852 2788 5522. Email: maylau@hkpc.org.

Successful applicants will be notified by email.

請填妥此報名表並傳真到+852 2788 5522 劉小姐收或電郵至 maylau@hkpc.org，成功獲取錄者將收到電郵確認。

請以正楷填寫此表格 Please complete this form in BLOCK LETTERS.

3C 及電子產品技術研討會

2015 年 6 月 3 日

Enquiry 查詢：

Ms May Lau (劉小姐)

Tel: (+852) 2788 6324

Email: maylau@hkpc.org

Mr Eric Kwan (關先生)

Tel: (+852) 2788 5529

Email: erickwan@hkpc.org

申請者資料 Applicant Info:

中文全名 Chinese Name:	英文全名 English Full Name:	職位 Position:	電郵 Email:
1 _____ (先生/小姐/太太/女士*)	_____ (Mr / Miss / Mrs / Ms*)	_____	_____
2 _____ (先生/小姐/太太/女士*)	_____ (Mr / Miss / Mrs / Ms*)	_____	_____
3 _____ (先生/小姐/太太/女士*)	_____ (Mr / Miss / Mrs / Ms*)	_____	_____
聯絡人姓名 Contact Person:		聯絡電話 Contact Number:	傳真 Fax:
聯絡電郵地址 Contact Email:			
公司名稱 Company Name:			
公司地址 Company Address:			
所屬的支持機構名稱 Name of Supporting Organization(s) belonged: (如適用 If applicable)			
<input type="checkbox"/> HKFSF 香港表面處理學會 <input type="checkbox"/> HKEPMA 香港電鍍業商會 <input type="checkbox"/> FITMI 香港創新科技及製造業聯合總會 <input type="checkbox"/> HKEAIA 香港電器業協會			
<input type="checkbox"/> HKMHDA 香港醫療及保健器材行業協會 <input type="checkbox"/> HKETA 香港電子科技商會 <input type="checkbox"/> HKAPIA 香港汽車零部件工業協會 <input type="checkbox"/> HKAIA 香港航空業協會			

聲明 Declaration：

本人聲明在此報名表格及隨附文件所載的資料，依本人所知均屬完整真確。本人已細閱並接受報名表內的所有條款及細則。

I declare that all information provided in this enrolment form and the accompanying documents are, to the best of my knowledge, true, accurate and complete. I have read and accepted all the terms and conditions of this enrolment form.

- ☐ 本人反對香港生產力促進局使用本人的個人資料，包括但不限於姓名、年齡、性別、電話號碼、傳真號碼、職位、會員身份、繳費資料包括信人卡資料（如適用）、學術及專業資格、通訊地址及電郵地址（“個人資料”）於推介該局最新發展、工業支援服務、顧問服務、培訓課程及相關的活動及其他由生產力局的推廣活動的用途。I object to the proposed use of my personal data including, without limitation, name, age, gender, phone number, fax number, job title, member status, payment details including credit card information (where applicable), academic and professional qualification, correspondence address and email address (“Personal Data”) for the purpose of sending me information relating to HKPC's latest developments, industry support services, consultancy services, training courses and related events, and other marketing activities as may be organized by HKPC.

申請者簽名

日期

Applicant' s Signature: 1. _____

Date: _____

申請者簽名

日期

Applicant' s Signature: 2. _____

Date: _____

申請者簽名

日期

Applicant' s Signature: 3. _____

Date: _____

條款及細則 Terms and Conditions:

1. 申請者可提名他人代替其本人出席研討會先須得本局同意。

An applicant may, subject to approval from HKPC, nominate a person to attend the seminar on his/her behalf.

2. 所收集的個人資料將會作入學申請、登記、學術、行政、研究、統計及市場分析及用於推介本局最新發展、工業支援服務、顧問服務、活動和培訓課程的用途。個人資料會嚴格保密處理。除非獲得閣下的同意，本局不會將個人資料轉移予第三者。本局已制定收集、使用及保留個人資料的政策，於報名處供索閱，閣下亦可向本局個人資料管理主任查詢。

Personal Data collected will be used for processing your application for admission, registration, academic, administrative, research and statistical purposes and will also be used for marketing purposes, specifically for the purpose of sending you information relating to HKPC's latest developments, industry support services, consultancy services, events and training courses. Personal Data will be treated in strict confidence. Unless otherwise agreed by you, Personal Data will not be transferred to any third parties. HKPC implements a policy governing the collection, use and retention of Personal Data, which is made available at the enrolment counter. You may also contact Personal Data Controlling Officer of HKPC for further details.

3. 香港生產力促進局保留在任何情況下及以任何原因拒絕任何人入學申請的權利。

HKPC reserves the right to reject any application in any circumstances and for whatever reasons.

4. 香港生產力促進局保留在任何情況下更改研討會地點、日期及時間的權利。

HKPC reserves the right to change the contents, venue and / or time as necessary.

5. 颱風及黑雨警告：如活動時間是在早上(09:00-13:00)、下午(14:00-17:00)或晚間(18:30-22:00)，將在下列情況下取消：(一)八號或以上颱風訊號或黑色暴雨警告訊號在早上 6:00、11:00 或下午 16:00 仍然懸掛；或(二)香港天文台在早上 6:00、11:00 或下午 4:00 或之後，宣佈將懸掛八號或以上颱風訊號或黑色暴雨警告訊號。本局將盡早通知學員活動的日期及時間。

HKPC reserves the right to change the contents, venue and / or time as necessary. Seminars in the morning, afternoon or evening will be cancelled if typhoon signal No. 8 or above OR black rainstorm warning is still hoisted after (or is announced by the Hong Kong Observatory to be hoisted at/after) 6:00 a.m., 11:00 a.m. and 4:00 p.m. respectively. Participants will be notified when the seminar will be made up as soon as possible.

6. 以上“條款及細則”內容均以本局單張及網頁公佈之最後更新版本為依歸。

These terms and conditions are subject to revisions as may be set out in the course pamphlets and the latest updates in the Institute's website.